



#### 60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	50mΩ @ V <sub>GS</sub> = 10V	18A
60V	63mΩ @ V <sub>GS</sub> = 4.5V	15A

### **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Power-Management Functions
- DC-DC Converters

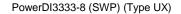
### **Features and Benefits**

- Rated to +175°C—Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low R<sub>DS(ON)</sub>—Ensures Minimal On-State Losses
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of the Board Area Occupied by SO-8 Enabling Smaller End Product
- Wettable Flank for Improved Optical Inspections
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMNH6069SFVWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

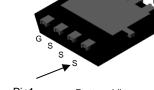
### **Mechanical Data**

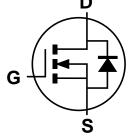
- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)





Top View





Pin1 Bottom View

**Equivalent Circuit** 

### **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMNH6069SFVWQ-7	PowerDI3333-8 (SWP) (Type UX)	2,000/Tape & Reel
DMNH6069SFVWQ-13	PowerDI3333-8 (SWP) (Type UX)	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**





# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	60	V		
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current V <sub>GS</sub> = 10V (Note 5)	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	I <sub>D</sub>	5.0 3.5	А
Continuous Drain Current V <sub>GS</sub> = 10V (Note 6)	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	lσ	18 12	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%	IDM	72	Α		
Maximum Continuous Body Diode Forward Current (Note 5)			Is	5.0	Α
Pulsed Source Current (380μs Pulse, Duty Cycle = 1%)			Ism	72	Α
Avalanche Current , L = 0.1mH			las	12	Α
Repetitive Avalanche Energy , L = 0.1mH			Eas	7.2	mJ

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	P <sub>D</sub>	3.0	W	
Thermal Resistance, Junction to Ambient (Note 5)  Steady State		Rөja	50	°C/W
Total Power Dissipation (Note 6)	P <sub>D</sub>	38	W	
Thermal Resistance, Junction to Case (Note 6)	Steady State	Rejc	3.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

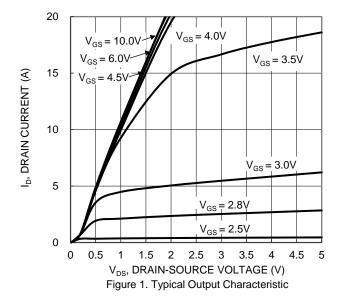
## Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	1	μΑ	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Process	_	35	50	mΩ	$V_{GS} = 10V, I_{D} = 3A$	
Static Dialit-Source Off-Resistance	RDS(ON)		41	63		$V_{GS} = 4.5V, I_{D} = 2.4A$	
Diode Forward Voltage	VsD		8.0	1.1	V	$V_{GS} = 0V$ , $I_{S} = 2.5A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		740		pF		
Output Capacitance	Coss		40	_	рF	$V_{DS} = 30V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	Crss		28	_	рF	1 = 1.0MHZ	
Gate Resistance	Rg	_	2.2	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	6.4		nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	14		nC	V 20V L 42A	
Gate-Source Charge	Qgs		2.8	_	nC	$V_{DS} = 30V, I_{D} = 12A$	
Gate-Drain Charge	Qgd		2.3	_	nC	1	
Turn-On Delay Time	tD(ON)		3.6	_	ns		
Turn-On Rise Time	t <sub>R</sub>		5.0	_	ns	V <sub>DS</sub> = 30V, I <sub>D</sub> = 12A	
Turn-Off Delay Time	tD(OFF)	_	12	_	ns	$V_{GS} = 10V, R_{G} = 6.0\Omega$	
Turn-Off Fall Time	tF	_	3.3	_	ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	11	_	ns		
Body Diode Reverse Recovery Charge	Qrr	_	5.1	_	nC	$I_F = 4.5A$ , di/dt = 100A/ $\mu$ s	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect. Notes:

8. Guaranteed by design. Not subject to product testing.





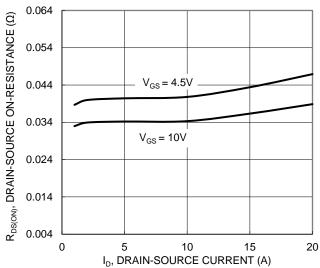


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

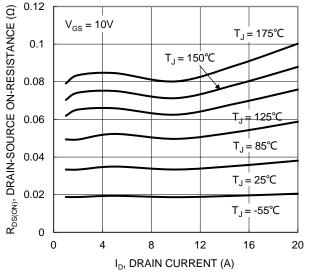


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

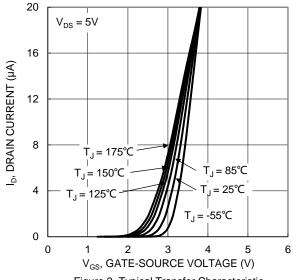


Figure 2. Typical Transfer Characteristic

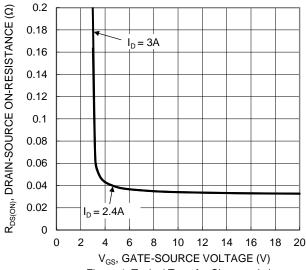


Figure 4. Typical Transfer Characteristic

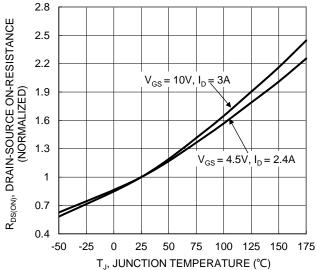


Figure 6. On-Resistance Variation with Junction Temperature



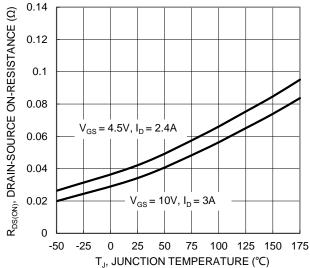


Figure 7. On-Resistance Variation with Temperature

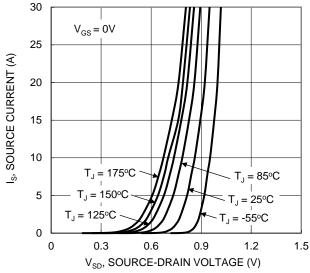
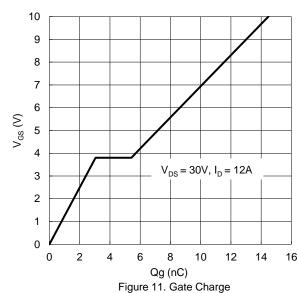


Figure 9. Diode Forward Voltage vs. Current



3  $V_{GS(TH)},\; GATE\; THRESHOLD\; VOLTAGE\; (V)$ 2.5 2  $I_D = 1mA$ 1.5  $I_{D} = 250 \mu A$ 1 0.5 0 50 100 125 150 175 -50 -25 25 75 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Temperature

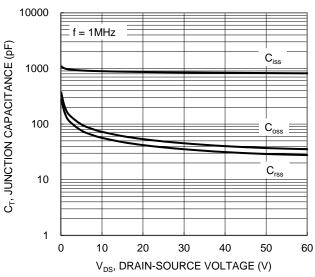
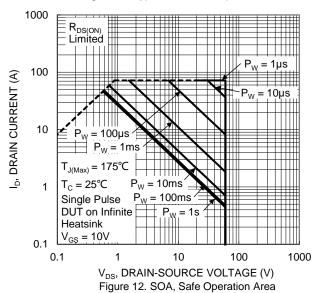


Figure 10. Typical Junction Capacitance





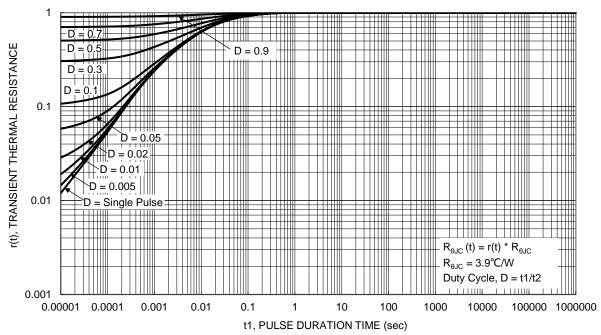


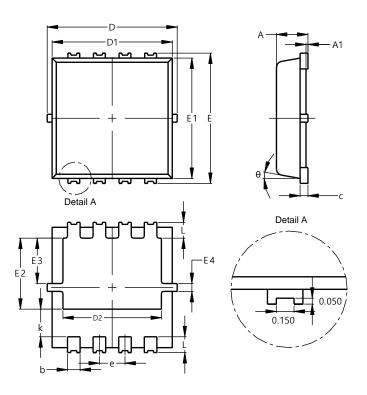
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8 (SWP) (Type UX)

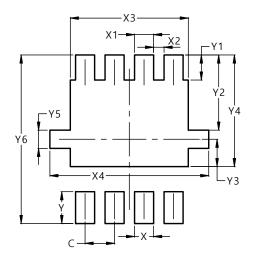


PowerDI3333-8 (SWP)						
(Type UX)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05				
p	0.25	0.40	0.32			
С	0.10	0.25	0.15			
D	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	2.30	2.70	2.50			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.60	2.00	1.80			
E3	0.95	1.35	1.15			
E4	0.10	0.30	0.20			
е	_	_	0.65			
k	0.50	0.90	0.70			
L	0.30	0.50	0.40			
θ	0°	12°	10°			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8 (SWP) (Type UX)



Dimensions	Value (in mm)		
С	0.650		
X	0.420		
X1	0.420		
X2	0.230		
Х3	2.600		
X4	3.500		
Y	0.700		
Y1	0.550		
Y2	1.650		
Y3	0.600		
Y4	2.450		
Y5	0.400		
Y6	3.700		



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